http://www.wto.org/english/tratop_e/inftec_e/itadec_e.htm INFORMATION TECHNOLOGY: MINISTERIAL DECLARATION Singapore, 13 December 1996

Ministerial Declaration on Trade in Information Technology Products

Ministers,

Representing the following Members of the World Trade Organization ("WTO"), and States or separate customs territories in the process of acceding to the WTO, which have agreed in Singapore on the expansion of world trade in information technology products and which account for well over 80 per cent of world trade in these products ("parties"):

Australia

Japan

Canada

Korea

Separate Customs Territory of Taiwan, Penghu, Kinmen and Matsu

Norway

European Communities

Singapore

Hong Kong

Switzerland

Iceland

Turkey

Indonesia

United States

Considering the key role of trade in information technology products in the development of information industries and in the dynamic expansion of the world economy,

Recognizing the goals of raising standards of living and expanding the production of and trade in goods;

Desiring to achieve maximum freedom of world trade in information technology products;

Desiring to encourage the continued technological development of the information technology industry on a world-wide basis;

Mindful of the positive contribution information technology makes to global economic growth and welfare;

Having agreed to put into effect the results of these negotiations which involve concessions additional to those included in the Schedules attached to the Marrakesh Protocol to the General Agreement on Tariffs and Trade 1994, and

Recognizing that the results of these negotiations also involve some concessions offered in negotiations leading to the establishment of Schedules annexed to the Marrakesh Protocol,

Declare as follows:

- 1. Each party's trade regime should evolve in a manner that enhances market access opportunities for information technology products.
- 2. Pursuant to the modalities set forth in the Annex to this Declaration, each party shall bind and eliminate customs duties and other duties and charges of any kind, within the meaning of Article II:1(b) of the General Agreement on Tariffs and Trade 1994, with respect to the following:

(a) all products classified (or classifiable) with Harmonized System (1996) ("HS") headings listed in Attachment A to the Annex to this Declaration; and(b) all products specified in Attachment B to the Annex to this Declaration, whether or not they are included in Attachment A;

through equal rate reductions of customs duties beginning in 1997 and concluding in 2000, recognizing that extended staging of reductions and, before implementation, expansion of product coverage may be necessary in limited circumstances.

3. Ministers express satisfaction about the large product coverage outlined in the Attachments to the Annex to this Declaration. They instruct their respective officials

to make good faith efforts to finalize plurilateral technical discussions in Geneva on the basis of these modalities, and instruct these officials to complete this work by 31 January 1997, so as to ensure the implementation of this Declaration by the largest number of participants.

4. Ministers invite the Ministers of other Members of the WTO, and States or separate customs territories in the process of acceding to the WTO, to provide similar instructions to their respective officials, so that they may participate in the technical discussions referred to in paragraph 3 above and participate fully in the expansion of world trade in information technology products.

Annex: Modalities and Product Coverage Attachment A: list of HS headings Attachment B: list of products

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Any Member of the World Trade Organization, or State or separate customs territory in the process of acceding to the WTO, may participate in the expansion of world trade in information technology products in accordance with the following modalities:

- Each participant shall incorporate the measures described in paragraph 2 of the Declaration into its schedule to the General Agreement on Tariffs and Trade 1994, and, in addition, at either its own tariff line level or the Harmonized System (1996) ("HS") 6-digit level in either its official tariff or any other published versions of the tariff schedule, whichever is ordinarily used by importers and exporters. Each participant that is not a Member of the WTO shall implement these measures on an autonomous basis, pending completion of its WTO accession, and shall incorporate these measures into its WTO market access schedule for goods.
- 2. To this end, as early as possible and no later than 1 March 1997 each participant shall provide all other participants a document containing (a) the details concerning how the appropriate duty treatment will be provided in its WTO schedule of concessions, and (b) a list of the detailed HS headings involved for products specified in Attachment B. These documents will be reviewed and approved on a consensus basis and this review process shall be completed no later than 1 April 1997. As soon as this review process has been completed for any such document, that document shall be submitted as a modification to the Schedule of the participant concerned, in accordance with the Decision of 26 March 1980 on Procedures for Modification and Rectification of Schedules of Tariff Concessions (BISD 275/25).

(a) The concessions to be proposed by each participant as modifications to itsSchedule shall bind and eliminate all customs duties and other duties and charges of any kind on information technology products as follows:

(i) elimination of such customs duties shall take place through rate reductions in equal steps, except as may be otherwise agreed by the participants. Unless otherwise agreed by the participants, each participant shall bind all tariffs on items listed in the Attachments no later than 1 July 1997, and shall make the first such rate reduction effective no later than 1 July 1997, the second such rate reduction no later than 1 January 1998, and the third such rate reduction no later than 1 January 1999, and the elimination of customs duties shall be completed effective no later than 1 January 2000. The participants agree to encourage autonomous elimination of customs duties prior to these dates. The reduced rate should in each stage be rounded off to the first decimal; and

(ii) elimination of such other duties and charges of any kind, within the meaning of Article II:1(b) of the General Agreement, shall be completed by 1 July 1997, except as may be otherwise specified in the participant's document provided to other participants for review.

(b) The modifications to its Schedule to be proposed by a participant in order to implement its binding and elimination of customs duties on information technology products shall achieve this result:

(i) in the case of the HS headings listed in Attachment A, by creating, where appropriate, sub-divisions in its Schedule at the national tariff line level; and

(ii) in the case of the products specified in Attachment B, by attaching an annex to its Schedule including all products in Attachment B, which is to specify the detailed HS headings for those products at either the national tariff line level or the HS 6-digit level.

Each participant shall promptly modify its national tariff schedule to reflect the modifications it has proposed, as soon as they have entered into effect.

3. Participants shall meet periodically under the auspices of the Council on Trade in Goods to review the product coverage specified in the Attachments, with a view to agreeing, by consensus, whether in the light of technological developments, experience in applying the tariff concessions, or changes to the HS nomenclature, the Attachments should be modified to incorporate additional products, and to consult on non-tariff barriers to trade in information technology products. Such consultations shall be without prejudice to rights and obligations under the WTO Agreement.

- 4. Participants shall meet as soon as practicable and in any case no later than 1 April 1997 to review the state of acceptances received and to assess the conclusions to be drawn therefrom. Participants will implement the actions foreseen in the Declaration provided that participants representing approximately 90 per cent of world trade in information technology products have by then notified their acceptance, and provided that the staging has been agreed to the participants' satisfaction. In assessing whether to implement actions foreseen in the Declaration, if the percentage of world trade represented by participants falls somewhat short of 90 per cent of world trade in information technology products, participants may take into account the extent of the participation of States or separate customs territories representing for them the substantial bulk of their own trade in such products. At this meeting the participants will establish whether these criteria have been met.
- 5. Participants shall meet as often as necessary and no later than 30 September 1997 to consider any divergence among them in classifying information technology products, beginning with the products specified in Attachment B. Participants agree on the common objective of achieving, where appropriate, a common classification for these products within existing HS nomenclature, giving consideration to interpretations and rulings of the Customs Co-operation Council (also known as the World Customs Organization or "WCO"). In any instance in which a divergence in classification remains, participants will consider whether a joint suggestion could be made to the WCO with regard to updating existing HS nomenclature.
- 6. The participants understand that Article XXIII of the General Agreement will address nullification or impairment of benefits accruing directly or indirectly to a WTO Member participant through the implementation of this Declaration as a result of the application by another WTO Member participant of any measure, whether or not that measure conflicts with the provisions of the General Agreement.
- Each participant shall afford sympathetic consideration to any request for consultation from any other participant concerning the undertakings set out above. Such consultations shall be without prejudice to rights and obligations under the WTO Agreement.
- 8. Participants acting under the auspices of the Council for Trade in Goods shall inform other Members of the WTO and States or separate customs territories in the process of acceding to the WTO of these modalities and initiate consultations with a view to facilitate their participation in the expansion of trade in information technology

products on the basis of the Declaration.

- 9. As used in these modalities, the term "participant" shall mean those Members of the WTO, or States or separate customs territories in the process of acceding to the WTO, that provide the document described in paragraph 2 no later than 1 March 1997.
- 10. This Annex shall be open for acceptance by all Members of the WTO and any State or any separate customs territory in the process of acceding to the WTO. Acceptances shall be notified in writing to the Director-General who shall communicate them to all participants.

There are two attachments to the Annex.

Attachment A lists the HS headings or parts thereof to be covered.

Attachment B lists specific products to be covered by an ITA wherever they are classified in the HS.

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HS96 HS description

3818 Chemical elements doped for use in electronics, in form of discs, wafers or similar forms; chemical compounds doped for use in electronics

8469 11 Word processing machines

8470 Calculating machines and pocketsize data recording, reproducing and displaying machines with a calculating function; accounting machines, postage franking machines, ticketissuing machines and similar machines, incorporating a calculating devices; cash registers:

8470 10 Electronic calculators capable of operating without an external source of electric power and pocket size data recording, reproducing and displaying machines with calculating functions

8470 21 Other electronic calculating machines incorporating a printing device

8470 29 Other

- 8470 30 Other calculating machines
- 8470 40 Accounting machines
- 8470 50 Cash registers
- 8470 90 Other

8471 Automatic data processing machines and units thereof; magnetic or optical readers, machines for transcribing data onto data media in coded form and machines for processing such data, not elsewhere specified or included:

8471 10 Analogue or hybrid automatic data processing machines

8471 30 Portable digital automatic data processing machines, weighing no more than 10 kg, consisting of at least a central processing unit, a keyboard and a display

8471 41 Other digital automatic data processing machines comprising in the same housing at least a central processing unit and an input and output unit, whether or not combined

8471 49 Other digital automatic data processing machines presented in the form of systems

8471 50 Digital processing units other than those of subheading 8471 41 and 8471 49, whether or not in the same housing one or two of the following types of units : storage units, input units, output units

8471 60 Input or output units, whether or not containing storage units in the same housing

8471 70 Storage units, including central storage units, optical disk storage units, hard disk drives and magnetic tape storage units

8471 80 Other units of automatic data processing machines

8471 90 Other

ex 8472 90 Automatic teller machines

8473 21 Parts and accessories of the machines of heading No 8470 of the electronic calculating machines of subheading 8470 10, 8470 21 and 8470 29

8473 29 Parts and accessories of the machines of heading No 8470 other than the electronic calculating machines of subheading 8470 10, 8470 21 and 8470 29

8473 30 Parts and accessories of the machines of heading No 8471

8473 50 Parts and accessories equally suitable for use with machines of two or more of the headings Nos. 8469 to 8472

ex 8504 40 Static converters for automatic data processing machines and units thereof, and telecommunication apparatus

ex 8504 50 Other inductors for power supplies for automatic data processing machines and units thereof, and telecommunication apparatus

8517 Electrical apparatus for line telephony or line telegraphy, including line telephone sets with cordless handsets and telecommunication apparatus for carriercurrent line systems or for digital line systems; videophones:

- 8517 11 Line telephone sets with cordless handsets
- 8517 19 Other telephone sets and videophones
- 8517 21 Facsimile machines
- 8517 22 Teleprinters
- 8517 30 Telephonic or telegraphic switching apparatus
- 8517 50 Other apparatus, for carriercurrent line systems or for digital line systems
- 8517 80 Other apparatus including entryphone systems
- 8517 90 Parts of apparatus of heading 8517

ex 8518 10 Microphones having a frequency range of 300 Hz to 3,4 KHz with a diameter of not exceeding 10 mm and a

height not exceeding 3 mm, for telecommunication use

ex 8518 30 Line telephone handsets

ex 8518 29 Loudspeakers, without housing, having a frequency range of 300 Hz to 3,4 KHz with a diameter of not

exceeding 50 mm, for telecommunication use

- 8520 20 Telephone answering machines
- 8523 11 Magnetic tapes of a width not exceeding 4 mm
- 8523 12 Magnetic tapes of a width exceeding 4 mm but not exceeding 6,5 mm
- 8523 13 Magnetic tapes of a width exceeding 6,5 mm
- 8523 20 Magnetic discs
- 8523 90 Other

8524 31 Discs for laser reading systems for reproducing phenomena other than sound or image ex 8524 39 Other :

for reproducing representations of instructions, data, sound, and image, recorded in a machine readable binary form, and capable of being manipulated or providing interactivity to a user, by means of an automatic data processing machine

8524 40 Magnetic tapes for reproducing phenomena other than sound or image

8524 91 Media for reproducing phenomena other than sound or image

ex 8424 99 Other:

for reproducing representations of instructions, data, sound, and image, recorded in a machine readable binary form, and capable of being manipulated or providing interactivity to a user, by means of an automatic data processing machine

ex 8525 10 Transmission apparatus other than apparatus for radiobroadcasting or television

8525 20 Transmission apparatus incorporating reception apparatus

- ex 8525 40 Digital still image video cameras
- ex 8527 90 Portable receivers for calling, alerting or paging
- ex 8529 10 Aerials or antennae of a kind used with apparatus for radiotelephony and radiotelegraphy
- ex 8529 90 Parts of:

transmission apparatus other than apparatus for radiobroadcasting or television

transmission apparatus incorporating reception apparatus

digital still image video cameras,

portable receivers for calling, alerting or paging

- 8531 20 Indicator panels incorporating liquid crystal devices (LCD) or light emitting diodes (LED)
- ex 8531 90 Parts of apparatus of subheading 8531 20
 - 8532 Electrical capacitors, fixed, variable or adjustable (preset):

8532 10 Fixed capacitors designed for use in 50/60 Hz circuits and having a reactive power handling capacity of not

less than 0,5 kvar (power capacitors)

- 8532 21 Tantalum fixed capacitors
- 8532 22 Aluminium electrolytic fixed capacitors
- 8532 23 Ceramic dielectric, single layer fixed capacitors
- 8532 24 Ceramic dielectric, multilayer fixed capacitors
- 8532 25 Dielectric fixed capacitors of paper or plastics
- 8532 29 Other fixed capacitors
- 8532 30 Variable or adjustable (preset) capacitors

8532 90 Parts 8533 Electrical resistors (including rheostats and potentiometers), other than heating resistors: 8533 10 Fixed carbon resistors, composition or film types Other fixed resistors for a power handling capacity not exceeding 20 W 8533 21 Other fixed resistors for a power handling capacity of 20 W or more 8533 29 Wirewound variable resistors, including rheostats and potentiometers, for a power handling capacity not 8533 31 exceeding 20 W 8533 Wirewound variable resistors, including rheostats and potentiometers, for a power handling capacity of 20 W 39 or more 8533 40 Other variable resistors, including rheostats and potentiometers 8533 90 Parts 8534 Printed circuits 50 Electronic AC switches consisting of optically coupled input and output circuits (Insulated thyristor AC ex 8536 switches) ex 8536 50 Electronic switches, including temperature protected electronic switches, consisting of a transistor and a logic chip (chiponchip technology) for a voltage not exceeding 1000 volts 8536 Electromechanical snapaction switches for a current not exceeding 11 amps ex 50 Plugs and sockets for coaxial cables and printed circuits ex 8536 69 8536 90 Connection and contact elements for wires and cables ex 8541 Diodes, transistors and similar semiconductor devices; photosensitive semiconductor devices, including photovoltaic cells whether or not assembled in modules or made up into panels; lightemitting diodes; mounted piezoelectric crystals: 8541 10 Diodes, other than photosensitive or lightemitting diodes Transistors, other than photosensitive transistors, with a dissipation rate of less than 1 W 8541 21 Transistors, other than photosensitive transistors, with a dissipation rate of 1 W or more 8541 29 8541 30 Thyristors, diacs and triacs, other than photosensitive devices 8541 40 Photosensitive semiconductor devices, including photovoltaic cells whether or not assembled in modules or made up into panels; light emitting diodes Other semiconductor devices 8541 50 60 Mounted piezoelectric crystals 8541 8541 90 Parts 8542 Electronic integrated circuits and microassemblies 8542 12 Cards incorporating an electronic integrated circuit ('smart' cards) 8542 13 Metal oxide semiconductors (MOS technology) 8542 Circuits obtained by bipolar technology 14 8542 19 Other monolithic digital integrated circuits, including circuits obtained by a combination of bipolar and MOS technologies (BIMOS technology)

8542 30 Other monolithic integrated circuits

- 8542 40 Hybrid integrated circuits
- 8542 50 Electronic microassemblies
- 8542 90 Part
- 8543 81 Proximity cards and tags
- ex 8543 89 Electrical machines with translation or dictionary functions
- ex 8544 41 Other electric conductors, for a voltage not exceeding 80 V, fitted with connectors, of a kind used for telecommunications
- ex 8544 49 Other electric conductors, for a voltage not exceeding 80 V, not fitted with connectors, of a kind used for telecommunications
- ex 8544 51 Other electric conductors, for a voltage exceeding 80 V but not exceeding 1000 V, fitted with connectors, of a kind used for telecommunications
 - 8544 70 Optical fibre cables
- 9009 11 Electrostatic photocopying apparatus, operating by reproducing the original image directly onto the copy (direct process)]
 - 9009 21 Other photocopying apparatus, incorporating an optical system

9009 90 Parts and accessories

9026 Instruments and apparatus for measuring or checking the flow, level, pressure or other variables of liquids or gases (for example, flow meters, level gauges, manometers, heat meters), excluding instruments and apparatus of heading No 9014, 9015, 9028 or 9032:

- 9026 10 Instruments for measuring or checking the flow or level of liquids
- 9026 20 Instruments and apparatus for measuring or checking pressure
- 9026 80 Other instruments and apparatus for measuring or checking of heading 9026
- 9026 90 Parts and accessories of instruments and apparatus of heading 9026
- 9027 20 Chromatographs and electrophoresis instruments
- 9027 30 Spectrometers, spectrophotometers and spectrographs using optical radiations (UV, visible, IR)
- 9027 50 Other instruments and apparatus using optical radiations (UV, visible, IR) of heading No 9027
- 9027 80 Other instruments and apparatus of heading No 9027 (other than those of heading No 9027 10)
- ex 9027 90 Parts and accessories of products of heading 9027, other than for gas or smoke analysis apparatus and microtomes
- 9030 40 Instruments and apparatus for measuring and checking, specially designed for telecommunications (for example, crosstalk meters, gain measuring instruments, distorsion factor meters, psophometers)

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Semiconductor manufacturing and testing equipment and parts thereof

HS Code Description Comments

- ex 7017 10 Quartz reactor tubes and holders designed for insertion into diffusion and oxidation furnaces for production of semiconductor wafers For Attachment B
- ex 8419 89 Chemical vapor deposition apparatus for semiconductor production For Attachment B
- ex 8419 90 Parts of chemical vapor deposition apparatus for semiconductor production For Attachment B

ex	8421 19	Spin dryers for semiconductor wafer processing
ex	8421 91	Parts of spin dryers for semiconductor wafer processing
ex	8424 89	Deflash machines for cleaning and removing contaminants from the metal leads of semiconductor packages
prior to the electroplating process		
ex 8424 89 Spraying appliances for etching, stripping or cleaning semiconductor wafers		
ex	8424 90	Parts of spraying appliances for etching, stripping or cleaning semiconductor wafers
ex	8456 10	Machines for working any material by removal of material, by laser or other light or photo beam in the
production of semiconductor wafers		
ex	8456 91	Apparatus for stripping or cleaning semiconductor wafers For Attachment B
		Achines for dryetching patterns on semiconductor materials
ex 8456 99 Focused ion beam milling machines to produce or repair masks and reticles for patterns on semiconductor		
	ices 8456 99	Lasercutters for cutting contacting tracks in semiconductor production by laser beam For Attachment B
ex		
ex	8464 10	Machines for sawing monocrystal semiconductor boules into slices, or wafers into chips For Attachment B
ex	8464 20	Grinding, polishing and lapping machines for processing of semiconductor wafers
ex	8464 90	Dicing machines for scribing or scoring semiconductor wafers
ex 8466 91 Parts for machines for sawing monocrystal semiconductor boules into slices, or wafers into chips For		
Attachment B		
ex	8466 91	Parts of dicing machines for scribing or scoring semiconductor wafers For Attachment B
ex	8466 91	Parts of grinding, polishing and lapping machines for processing of semiconductor wafers
ex	8466 93	Parts of focused ion beam milling machines to produce or repair masks and reticles for patterns on
semiconductor devices		
ex	8466 93	Parts of lasercutters for cutting contacting tracks in semiconductor production by laser beam For
Attachment B		
ex	8466 93	Parts of machines for working any material by removal of material, by laser or other light or photo beam in
the production of semiconductor wafers		
ex	8456 93	Parts of apparatus for stripping or cleaning semiconductor wafers For Attachment B
ex	8466 93	Parts of machines for dryetching patterns on semiconductor materials
ex	8477 10	Encapsulation equipment for assembly of semiconductors For Attachment B
ex	8477 90	Parts of encapsulation equipment For Attachment B
ex	8479 50	Automated machines for transport, handling and storage of semiconductor wafers, wafer cassettes, wafer
boxes and other material for semiconductor devices For Attachment B		
ex	8479 89	Apparatus for growing or pulling monocrystal semiconductor boules
ex	8479 89	Apparatus for physical deposition by sputtering on semiconductor wafers For Attachment B
ex	8479 89	Apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays
For Attachment B		
ex	8479 89	Die attach apparatus, tape automated bonders, and wire bonders for assembly of semiconductors For
Attachment B		
ex	8479 89	Encapsulation equipment for assembly of semiconductors For Attachment B

ex 8479 89 Epitaxial deposition machines for semiconductor wafers Machines for bending, folding and straightening semiconductor leads For Attachment B ex 8479 89 8479 89 Physical deposition apparatus for for semiconductor production For Attachment B ex 8479 89 Spinners for coating photographic emulsions on semiconductor wafers For Attachment B ex ex 8479 90 Part of apparatus for physical deposition by sputtering on semiconductor wafers For Attachment B ex 8479 90 Parts for die attach apparatus, tape automated bonders, and wire bonders for assembly of semiconductors For Attachment B 8479 90 Parts for spinners for coating photographic emulsions on semiconductor wafers For Attachment B ex 8479 90 Parts of apparatus for growing or pulling monocrystal semiconductor boules ex 8479 90 Parts of apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays For Attachment B ex 8479 90 Parts of automated machines for transport, handling and storage of semiconductor wafers, wafer cassettes, wafer boxes and other material for semiconductor devices For Attachment B ex 8479 90 Parts of encapsulation equipment for assembly of semiconductors For Attachment B ex 8479 90 Parts of epitaxial deposition machines for semiconductor wafers ex 8479 90 Parts of machines for bending, folding and straightening semiconductor leads For Attachment B ex 8479 90 Parts of physical deposition apparatus for for semiconductor production For Attachment B ex 8480 71 Injection and compression moulds for the manufacture of semiconductor devices 8514 10 Resistance heated furnaces and ovens for the manufacture of semiconductor devices on semiconductor ex wafers ex 8514 20 Inductance or dielectric furnaces and ovens for the manufacture of semiconductor devices on semiconductors wafers ex 8514 30 Apparatus for rapid heating of semiconductor wafers For Attachment B ex 8514 30 Parts of resistance heated furnaces and ovens for the manufacture of semiconductor devices on semiconductor wafers ex 8514 90 Parts of apparatus for rapid heating of wafers For Attachment B ex 8514 90 Parts of furnaces and ovens of Headings No 8514 10 to No 8514 30 ex 8536 90 Wafer probers For Attachment B 8543 11 Ion implanters for doping semiconductor materials ex 8543 30 Apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays For Attachment B ex 8543 90 Parts of apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays For Attachment B ex 8543 90 Parts of ion implanters for doping semiconductor materials 9010 41 to 9010 49 Apparatus for projection, drawing or plating circuit patterns on sensitized semiconductor materials and flat panel displays ex 9010 90 Parts and accessories of the apparatus of Headings No 9010 41 to 9010 49 ex 9011 10 Optical stereoscopic microscopes fitted with equipment specifically designed for the handling and transport

of semiconductor wafers or reticles For Attachment B

ex 9011 20 Photomicrographic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles For Attachment B

ex 9011 90 Parts and accessories of optical stereoscopic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles For Attachment B

ex 9011 90 Parts and accessories of photomicrographic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles For Attachment B

ex 9012 10 Electron beam microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles For Attachment B

ex 9012 90 Parts and accessories of electron beam microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles For Attachment B

ex 9017 20 Pattern generating apparatus of a kind used for producing masks or reticles from photoresist coated substrates For Attachment B

ex 9017 90 Parts and accessories for pattern generating apparatus of a kind used for producing masks or reticles from photoresist coated substrates For Attachment B

ex 9017 90 Parts of such pattern generating apparatus For Attachment B

9030 82 Instruments and apparatus for measuring or checking semiconductor wafers or devices

ex 9030 90 Parts and accessories of instruments and apparatus for measuring or checking semiconductor wafers or devices

ex 9030 90 Parts of instruments and appliances for measuring or checking semiconductor wafers or devices

9031 41 Optical instruments and appliances for inspecting semiconductor wafers or devices or for inspecting masks, photomasks or reticles used in manufacturing semiconductor devices

ex 9031 49 Optical instruments and appliances for measuring surface particulate contamination on semiconductor wafers

ex 9031 90 Parts and accessories of optical instruments and appliances for inspecting semiconductor wafers or devices or for inspecting masks, photomasks or reticles used in manufacturing semiconductor devices

ex 9031 90 Parts and accessories of optical instruments and appliances for measuring surface particulate contamination on semiconductor wafers

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Positive list of specific products to be covered by this agreement wherever they are classified in the HS.

Where parts are specified, they are to be covered in accordance with HS Notes 2(b) to Section XVI and Chapter 90, respectively.

Computers: automatic data processing machines capable of 1) storing the processing program or programs and at least the data immediately necessary for the execution of the program; 2) being freely programmed in accordance with the requirements of the user; 3) performing arithmetical computations specified by the user; and 4) executing, without human intervention, a processing program which requires them to modify their execution, by logical decision during the processing run.

The agreement covers such automatic data processing machines whether or not they are able to receive and process with the assistance of central processing unit telephony signals, television signals, or other analogue or digitally processed audio or video signals. Machines performing a specific function other than data processing, or incorporating or working in conjunction with an automatic data processing machine, and not otherwise specified under Attachment A or B, are not covered by this agreement.

Electric amplifiers when used as repeaters in line telephony products falling within this agreement, and parts thereof Flat panel displays (including LCD, Electro Luminescence, Plasma and other technologies) for products falling within this agreement, and parts thereof.

Network equipment: Local Area Network (LAN) and Wide Area Network (WAN) apparatus, including those products dedicated for use solely or principally to permit the interconnection of automatic data processing machines and units thereof for a network that is used primarily for the sharing of resources such as central processor units, data storage devices and input or output units including adapters, hubs, inline repeaters, converters, concentrators, bridges and routers, and printed circuit assemblies for physical incorporation into automatic data processing machines and units thereof.

Monitors : display units of automatic data processing machines with a cathode ray tube with a dot screen pitch smaller than 0,4 mm not capable of receiving and processing television signals or other analogue or digitally processed audio or video signals without assistance of a central processing unit of a computer as defined in this agreement.

The agreement does not, therefore, cover televisions, including high definition televisions.

Optical disc storage units, for automatic data processing machines (including CD drives and DVDdrives), whether or not having the capability of writing/recording as well as reading, whether or not in their own housings. Paging alert devices , and parts thereof .

Plotters whether input or output units of HS heading No 8471 or drawing or drafting machines of HS heading No 9017. Printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard.

Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542.

Projection type flat panel display units used with automatic data processing machines which can display digital information generated by the central processing unit.

Proprietary format storage devices including media therefor for automatic data processing machines, with or without removable media and whether magnetic, optical or other technology, including Bernoulli Box, Syquest, or Zipdrive cartridge storage units.

Multimedia upgrade kits for automatic data processing machines, and units thereof, put up for retail sale, consisting of, at least, speakers and/or microphones as well as a printed circuit assembly that enables the ADP machines and units thereof to process audio signals (sound cards).

Set top boxes which have a communication function : a microprocessorbased device incorporating a modem for gaining

access to the Internet, and having a function of interactive information exchange